# PHILIPS INTERNATIONAL

### Philips Semiconductors

Data sheet			
status	Preliminary specification		
date of issue	December 1990		

# 2N2646 Silicon unijunction transistor

#### **QUICK REFERENCE DATA**

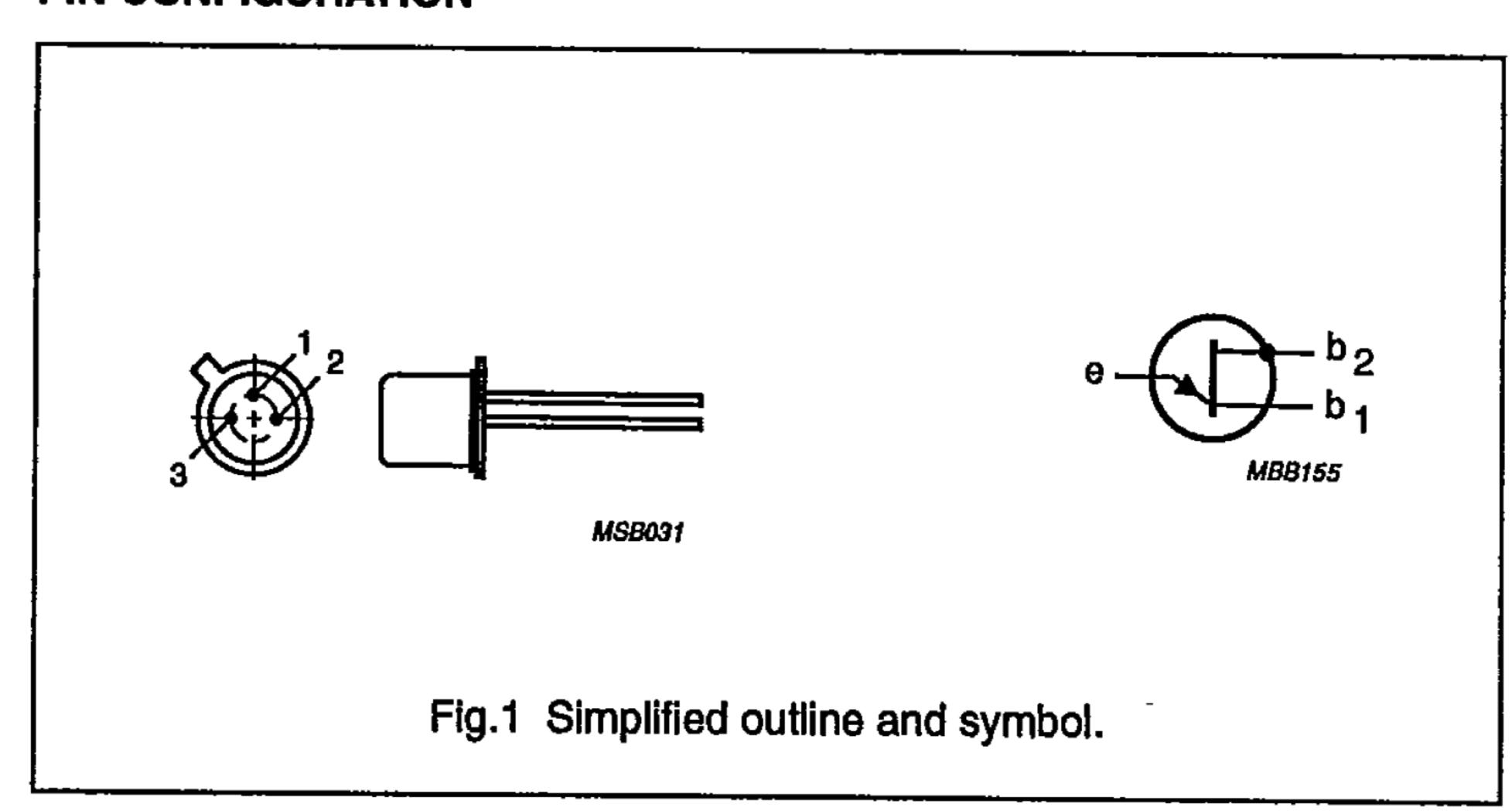
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
-V <sub>EB2</sub>	emitter-base 2 voltage		_	_	30	\ <u>\</u>
IEM	emitter current	peak value	_	_	2	A
P <sub>tot</sub>	total power dissipation		_		300	mW
T <sub>i</sub>	junction temperature			_	125	°C
R <sub>BB</sub>	static inter-base resistance	$V_{B2B1} = 3 V$ $I_E = 0$	_	7	-	kΩ
V <sub>EB1 sat</sub>	emitter-base 1 saturation voltage	$V_{B2B1} = 10 \text{ V}$ $I_E = 50 \text{ mA}$	-	3.5	_	٧
E(V)	emitter valley point current		4	6	_	mA
I <sub>E(P)</sub>	emitter peak point current			1	5	μΑ

#### PINNING - TO-18

Base 2 connected to case.

PIN	DESCRIPTION
1	emitter
2	base 1
3	base 2

### **PIN CONFIGURATION**



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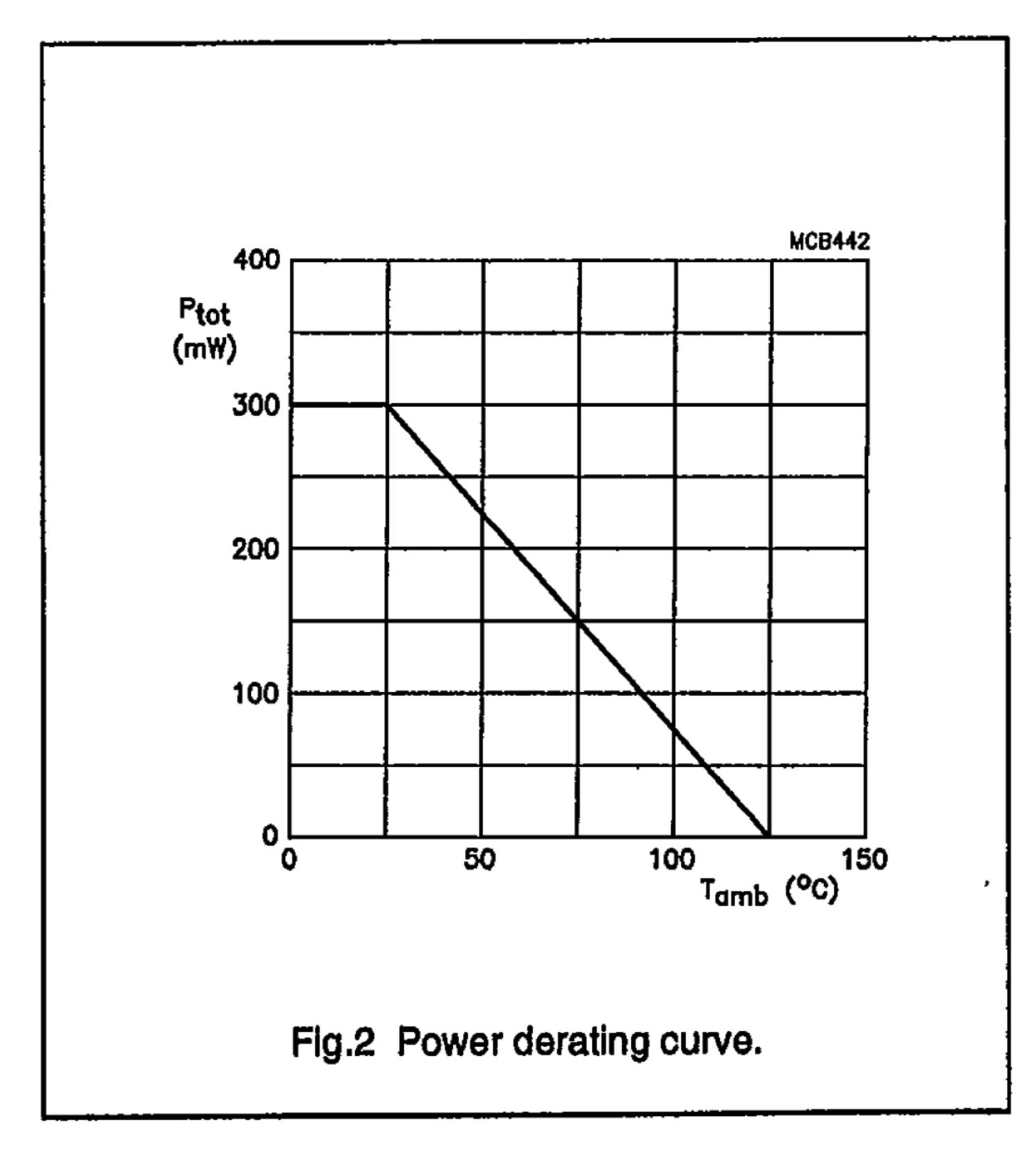
### **LIMITING VALUES**

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL.	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
-V <sub>EB2</sub>	emitter-base 2 voltage		_	30	٧
V <sub>B2B1</sub>	inter-base voltage		_	35	٧
l <sub>E</sub>	emitter current	average value		50	mA
EM	emitter current (note 1)	peak value	_	2	Α
Ptot	total power dissipation (note 2)	T <sub>amb</sub> ≤ 25 °C		300	mW
T <sub>etg</sub>	storage temperature range		-65	150	°C
<u></u>	junction temperature		_	125	°C

#### Notes

- 1. Capacitor discharge ≤ 10 μF at ≤ 30 V.
- 2. Must be limited by external circuit.



### THERMAL RESISTANCE

SYMBOL	PARAMETER	VALUE	UNIT
R <sub>th J-a</sub>	from junction to ambient	300	K/W

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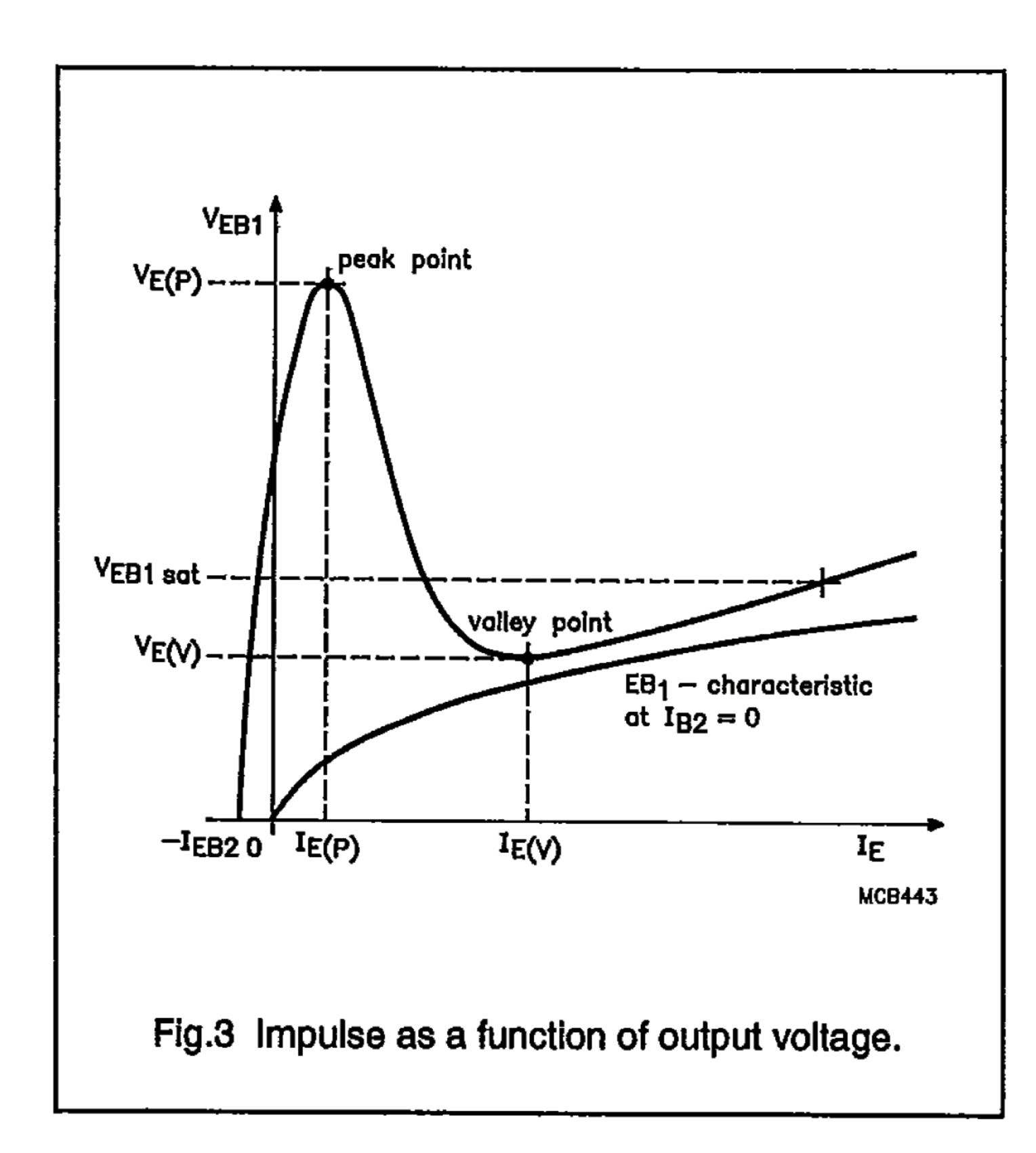
#### **CHARACTERISTICS**

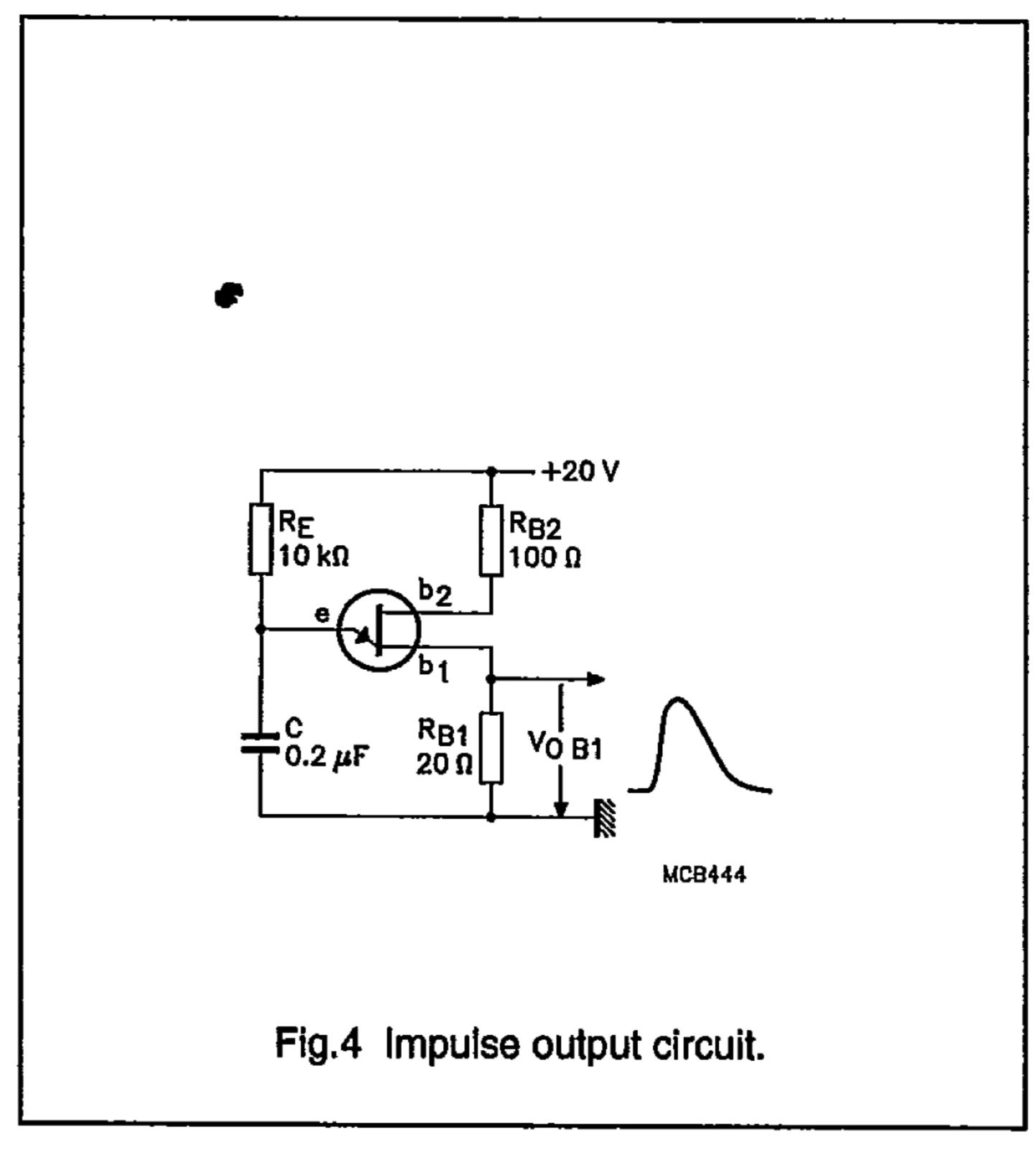
 $T_{amb} = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>BB</sub>	static inter-base resistance	$V_{B2B1} = 3 V$ $I_E = 0$	4.7	7	9.1	kΩ
TC <sub>RBB</sub>	inter-base resistance temperature coefficient	$V_{82B1} = 3 V$ $I_E = 0$ $T_{amb} = -55 \text{ to } 125 ^{\circ}\text{C}$	0.1		0.9	%/K
-I <sub>EB2O</sub>	emitter cut-off current	$-V_{EB2} = 30 \text{ V}$ $I_{B1} = 0$	_	-	12	٧
V <sub>EB1sat</sub>	emitter-base 1 saturation voltage	$V_{B2B1} = 10 \text{ V}$ $I_E = 50 \text{ mA}$		3.5		٧
B2mod	inter-base current modulation	$V_{B2B1} = 10 \text{ V}$ $I_E = 50 \text{ mA}$	_	15		mA
η	input/output ratio (note 1)	$V_{B2B1} = 10 \text{ V}$	0.56	_	0.75	
E(V)	emitter valley point current	$V_{B2B1} = 20 \text{ V}$ $R_{B2} = 100 \Omega$	4	6	_	mA
I <sub>E(P)</sub>	emitter peak point current	$V_{B2B1} = 25 \text{ V}$	_	1	5	μΑ
V <sub>OB1M</sub>	base 1 impulse/output voltage		3	5	-	٧

#### Note

1.  $\eta = \frac{(V_{E(P)} - V_{EB1})}{V_{B2B1}}$ , when  $V_{E(P)} =$  emitter peak point voltage,  $V_{EB1} =$  emitter-base 1 breakdown voltage, (approximately 0.5 V at 10  $\mu$ A), and  $V_{B2B1} =$  inter-base voltage.

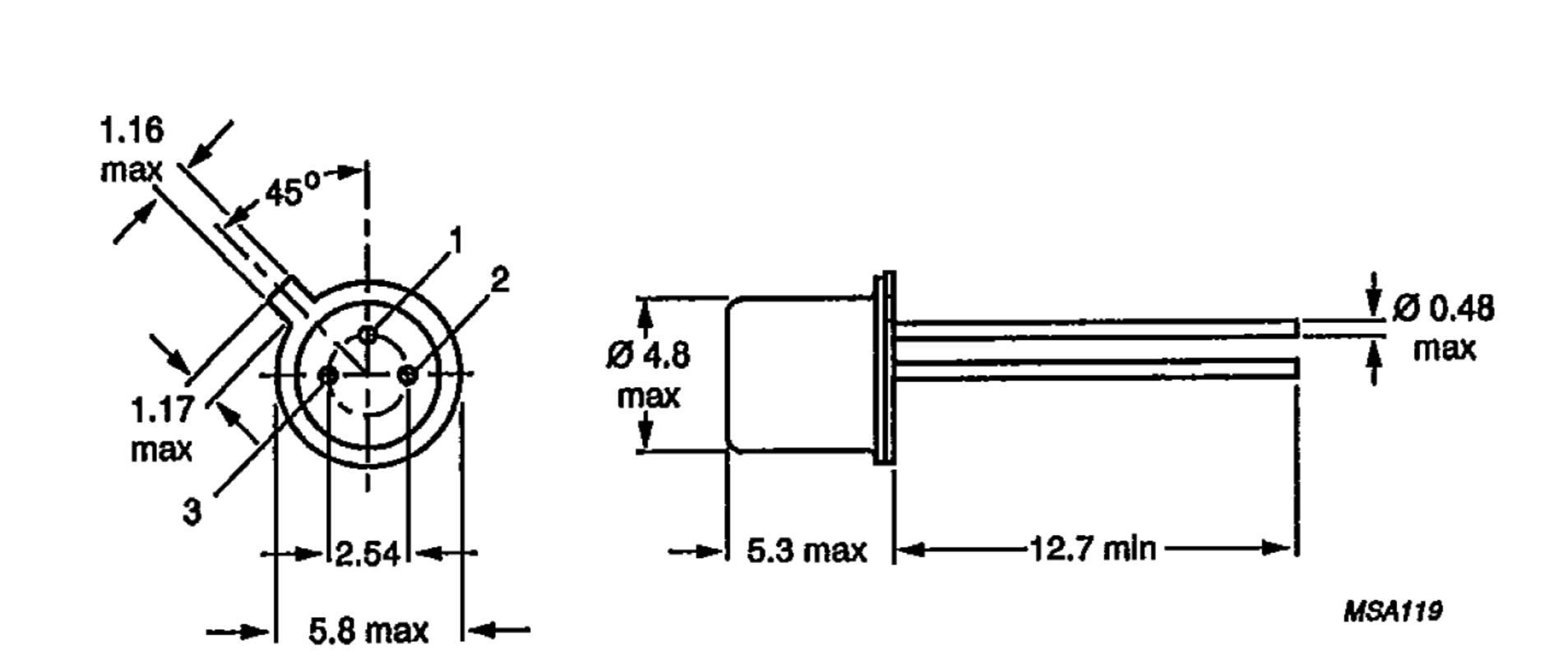




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#### PACKAGE OUTLINE



Dimensions in mm.

Fig.5 TO-18.